XP04654 (XP4654)

Silicon NPN epitaxial planar type (Tr1) Silicon PNP epitaxial planar type (Tr2)

For high-speed switching

■ Features

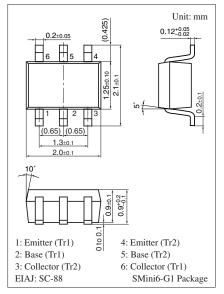
- Two elements incorporated into one package
- Reduction of the mounting area and assembly cost by one half

■ Basic Part Number

• 2SC3757 + 2SA1738

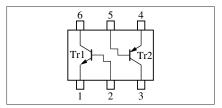
■ Absolute Maximum Ratings T_a = 25°C

	Parameter	Symbol	Rating	Unit	
Tr1	Collector-base voltage (Emitter open)	V _{CBO}	40	V	
	Collector-emitter voltage (E-B short)	V _{CES}	40	V	
	Emitter-base voltage (Collector open)	V _{EBO}	5	V	
	Collector current	I_C	100	mA	
	Peak collector current	I_{CP}	300	mA	
Tr2	Collector-base voltage (Emitter open)	V _{CBO}	-15	V	
	Collector-emitter voltage (E-B short)	V _{CES}	-15	V	
	Emitter-base voltage (Collector open)	V _{EBO}	-4	V	
	Collector current	I_{C}	-50	mA	
	Peak collector current	I_{CP}	-100	mA	
Overall	Total power dissipation	P _T	150	mW	
	Junction temperature	T_j	150	°C	
	Storage temperature	T _{stg}	-55 to +150	°C	



Marking Symbol: ED

Internal Connection



Note) The part number in the parenthesis shows conventional part number.

■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

• Tr1

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 40 \text{ V}, I_E = 0$			0.1	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 4 \text{ V}, I_C = 0$			0.1	μΑ
Forward current transfer ratio	h _{FE}	$V_{CE} = 1 \text{ V}, I_{C} = 10 \text{ mA}$	60		320	_
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$		0.17	0.25	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 10 \text{ mA}, I_B = 1 \text{ mA}$			1.0	V
Transition frequency	f_T	$V_{CB} = 10 \text{ V}, I_{E} = -10 \text{ mA}, f = 200 \text{ MHz}$		450		MHz
Collector output capacitance	C _{ob}	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		2	6	pF
(Common base, input open circuited)						
Turn-on time	t _{on}	Refer to the switching time measurement		17		ns
Turn-off time	t _{off}	circuit		17		ns
Storage time	t _{stg}			10		ns

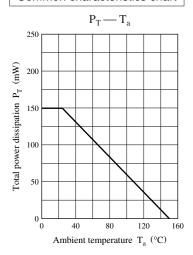
 $Note)\ Measuring\ methods\ are\ based\ on\ JAPANESE\ INDUSTRIAL\ STANDARD\ JIS\ C\ 7030\ measuring\ methods\ for\ transistors.$

• Tr2

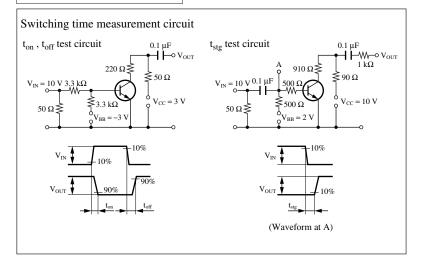
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = -8 \text{ V}, I_E = 0$			- 0.1	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = -3 \text{ V}, I_C = 0$			- 0.1	μΑ
Forward current transfer ratio	h _{FE1}	$V_{CE} = -1 \text{ V}, \ I_{C} = -10 \text{ mA}$	50		150	_
	h _{FE2}	$V_{CE} = -1 \text{ V}, I_{C} = -1 \text{ mA}$	30			
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = -10 \text{ mA}, I_B = -1 \text{ mA}$		- 0.1	- 0.2	V
Transition frequency	f_T	$V_{CB} = -10 \text{ V}, I_E = 10 \text{ mA}, f = 200 \text{ MHz}$	800	1500		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = -5 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		1		pF
Turn-on time	t _{on}	Refer to the switching time measurement circuit		12		ns
Turn-off time	t _{off}			20		ns
Storage time	t _{stg}			19		ns

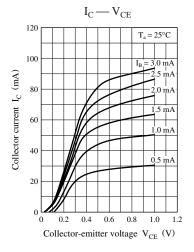
Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

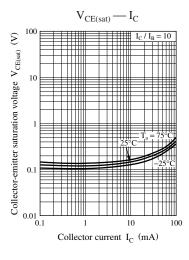
Common characteristics chart

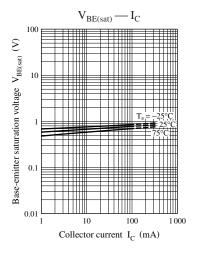


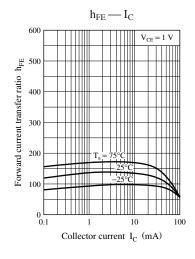
Characteristics charts of Tr1

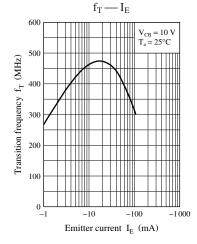


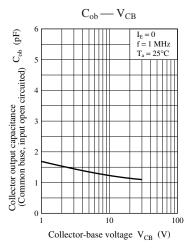




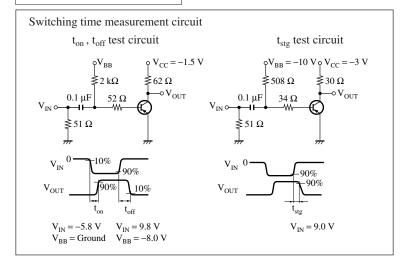


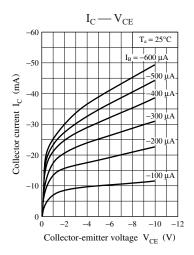


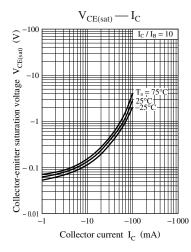


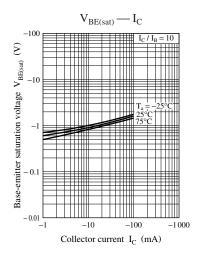


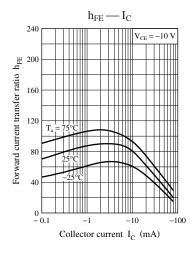
Characteristics charts of Tr2

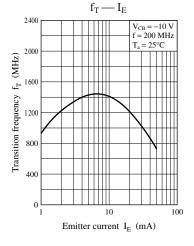


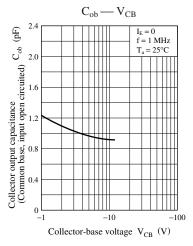












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